Build in Biasing Circuit MOS FET IC UHF RF Amplifier

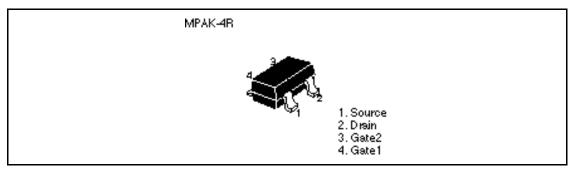
HITACHI

ADE-208-713A (Z) 2nd. Edition Dec. 1998

Features

- Build in Biasing Circuit; To reduce useing parts cost & PC board space.
- Low noise characteristics;
 - (NF = 2.0 dB typ. at f = 900 MHz)
- Withstanding to ESD;
 - Build in ESD absorbing diode. Withstand up to 200V at C=200pF, Rs=0 conditins.
- Provide mini mold packages; MPAK-4R(SOT-143 var.)

Outline



Notes: 1. Marking is "AV-".

2. BB201M is individual type number of HITACHI BBFET.



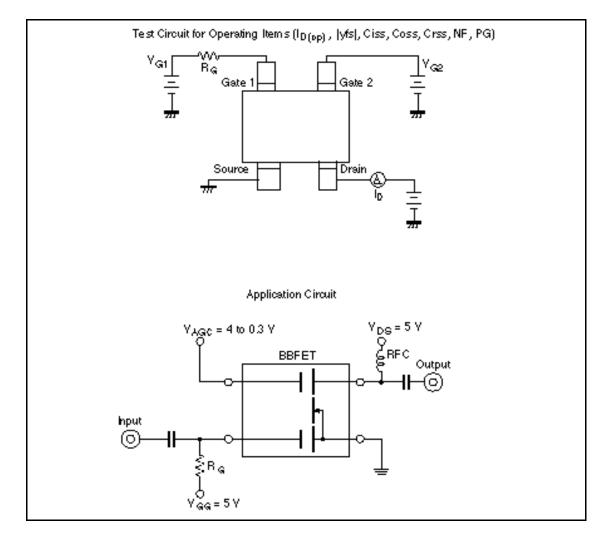
Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

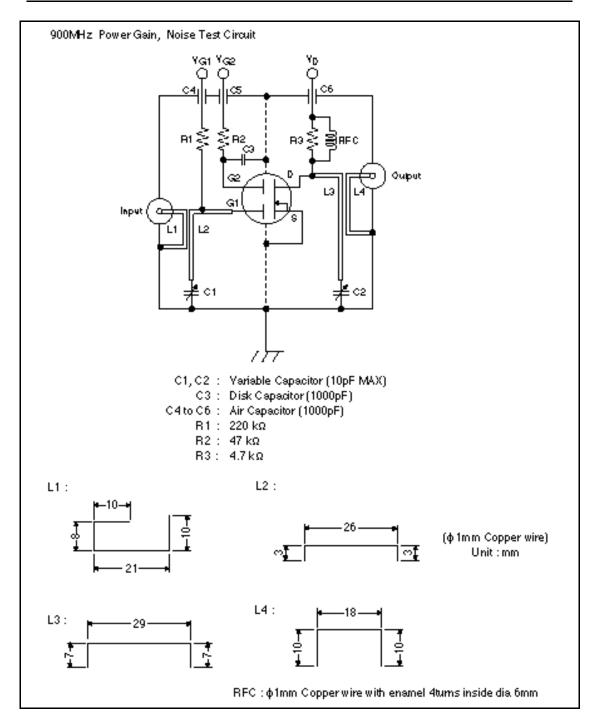
Item	Symbol	Ratings	Unit	
Drain to source voltage	V _{DS}	6	V	
Gate1 to source voltage	V_{g1S}	+6 - 0	V	
Gate 2 to source voltage	V _{G2S}	±6	V	
Drain current	I _D	25	mA	
Channel power dissipation	Pch	150	mW	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{\rm (BR)DSS}$	6		_	V	$I_{D} = 200 \mu A, V_{G1S} = V_{G2S} = 0$
Gate1 to source breakdown voltage	$V_{\rm (BR)G1SS}$	+6	_	_	V	$I_{_{G1}}$ = +10µA, $V_{_{G2S}}$ = $V_{_{DS}}$ = 0
Gate2 to source breakdown voltage	$V_{(BR)G2SS}$	±6		_	V	$I_{_{\rm G2}} = \pm 10 \mu A, V_{_{\rm G1S}} = V_{_{\rm DS}} = 0$
Gate1 to cutoff current	I_{G1SS}	_	_	+100	nA	V_{G1S} = +5V, V_{G2S} = V_{DS} = 0
Gate2 to cutoff current	I _{G2SS}	_	_	±100	nA	$V_{\text{G2S}}=\pm 5V, \ V_{\text{G1S}}=V_{\text{DS}}=0$
Gate1 to source cutoff voltage	$V_{\text{G1S(off)}}$	0.2	0.45	0.8	V	$V_{DS} = 5V, V_{G2S} = 4V$ $I_{D} = 100 \mu A$
Gate2 to source cutoff voltage	$V_{\text{G2S(off)}}$	0.4	0.7	1.0	V	$V_{DS} = 5V, V_{G1S} = 5V$ $I_{D} = 100 \mu A$
Drain current	I _{D(op)}	10	15	20	mA	$V_{DS} = 5V, V_{G1} = 5V, V_{G2S} = 4V$ $R_{G} = 220k$
Forward transfer admittance	y _{fs}	16	22	_	mS	$V_{DS} = 5V, V_{G1} = 5V, V_{G2S} = 4V$ $R_{g} = 220k$, $f = 1kHz$
Input capacitance	$\mathbf{C}_{\mathrm{iss}}$	1.2	1.7	2.2	pF	$V_{\rm DS} = 5V, V_{\rm G1} = 5V$
Output capacitance	C _{oss}	0.7	1.1	1.5	pF	$V_{G2S} = 4V, R_{G} = 220k$
Reverse capacitance	C _{rss}	_	0.012	0.03	pF	f = 1MHz
Power gain	PG	16	20	—	dB	$V_{\rm DS} = 5V, V_{\rm G1} = 5V, V_{\rm G2S} = 4V$
Noise figure	NF	_	2.0	3.0	dB	$R_{g} = 220k$, f = 900MHz

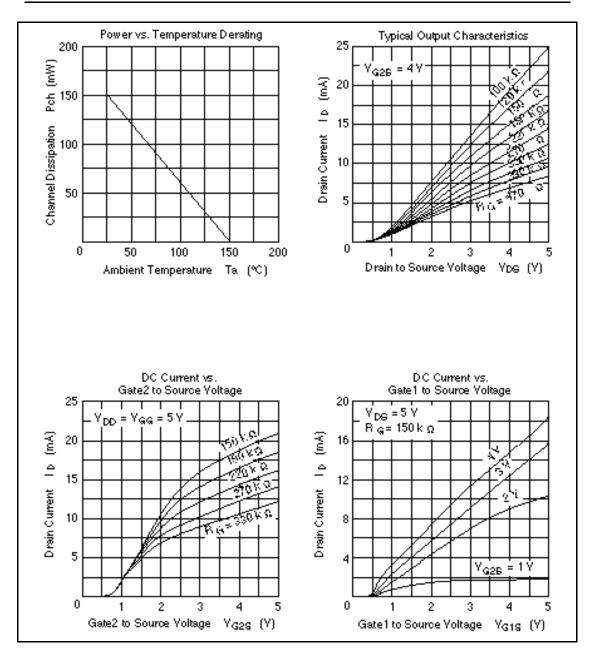
Main Characteristics

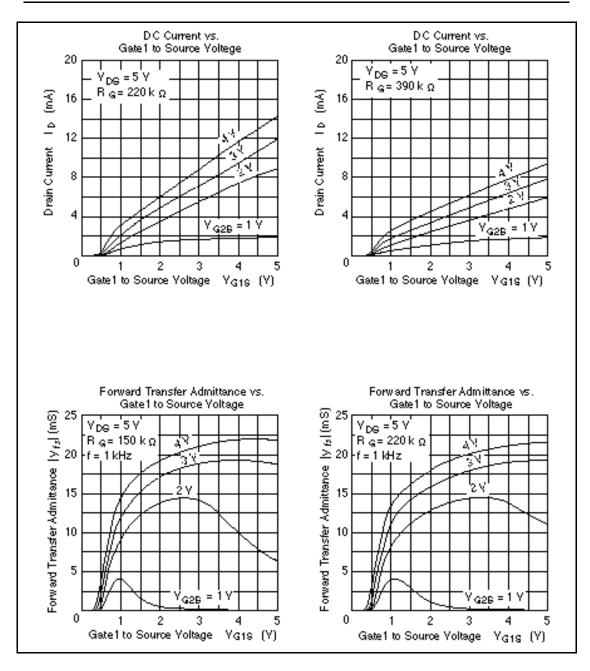


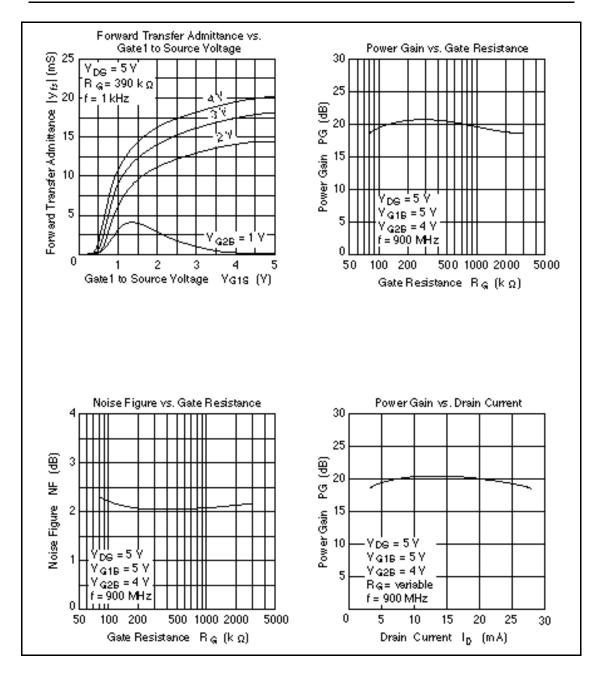


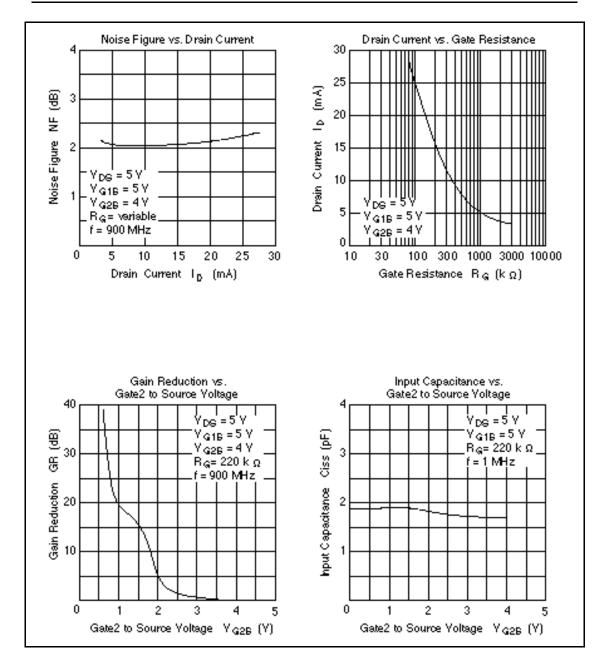
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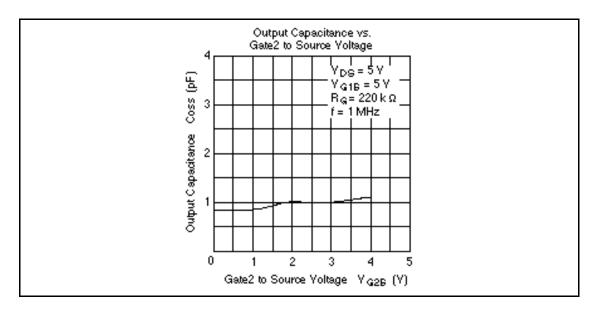
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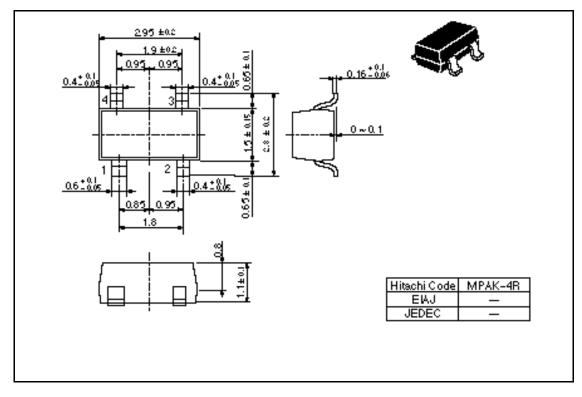






Package Dimensions





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